

INPUT

parameter	conditions/description	min	typ	max	units
voltage ⁴	ac input	85		305	Vac
	dc input	100		430	Vdc
frequency		47	50~60	63	Hz
current	115 Vac			0.13	A
	230 Vac			0.07	A
external input fuse	1 A, slow-blow, required				
leakage current	230 Vac/50 Hz			0.3	mA
no load power consumption	at 230 Vac		0.1		W

Notes: 4. The input voltage should not exceed the specified range value to prevent permanent and irreparable damage.

OUTPUT

parameter	conditions/description	min	typ	max	units
capacitive load	3.3 Vdc output model			4,000	μF
	5 Vdc output model			3,000	μF
	9, 12 Vdc output model			1,200	μF
	15 Vdc output model			680	μF
	24 Vdc output model			220	μF
output voltage accuracy	5% ~ 100% load				
	3.3 Vdc output model all other output models		±3 ±2		% %
line regulation			±0.5		%
load regulation	5% ~ 100% load		±1.0		%
hold-up time	at 230 Vac		50		ms
temperature coefficient			±0.02		%/°C

PROTECTIONS

parameter	conditions/description	min	typ	max	units
over current protection	auto recovery	110			%
short circuit protection	continuous, auto recovery				

SAFETY & COMPLIANCE

parameter	conditions/description	min	typ	max	units
isolation voltage	input to output, for 1 minute, 5mA max	4,000			Vac
safety approvals	certified to 62368-1: IEC, EN, UL designed to meet 61558: EN designed to meet 60335: EN				
safety class	Class II				
EMI/EMC	CISPR32/EN55032 CLASS B				
ESD	IEC/EN61000-4-2 Contact ±6 kV/Air ±8 kV, perf. Criteria B				
radiated immunity	IEC/EN61000-4-3 10 V/m, perf. Criteria A				
EFT/burst	IEC/EN61000-4-4 ±4 kV (see recommended circuit Fig. 2), perf. Criteria B				
surge	IEC/EN61000-4-5 line to line ±1 kV, perf. Criteria B				
	IEC/EN61000-4-5 line to line ±2 kV, (see recommended circuit Fig. 2), perf. Criteria B				
conducted immunity	IEC/EN61000-4-6 10 Vrms, perf. Criteria A				
MTBF	MIL-HDBK-217F at 25°C	2,600,000			hours
RoHS	yes				

ENVIRONMENTAL

parameter	conditions/description	min	typ	max	units
operating temperature		-40		85	°C
storage temperature		-40		105	°C
storage humidity	non-condensing	0		95	%

SOLDERABILITY

parameter	conditions/description	min	typ	max	units
wave soldering	5~10 seconds max	255	260	265	°C
hand soldering	3~5 seconds max	355	360	360	°C

MECHANICAL

parameter	conditions/description	min	typ	max	units
dimensions	board mount: 25.40 x 25.40 x 17.60 [1.000 x 1.000 x 0.693 inch]				mm
	chassis mount: 76.00 x 31.50 x 26.40 [2.992 x 1.240 x 0.906 inch]				mm
	DIN-rail mount: 76.00 x 31.50 x 27.40 [2.992 x 1.240 x 1.079 inch]				mm
weight	board mount		23.0		g
	chassis mount		41.58		g
	DIN-rail mount		61.40		g
case material	black plastic, flame-retardant and heat-resistant (UL94V-0)				
cooling	natural convection				

MECHANICAL DRAWING

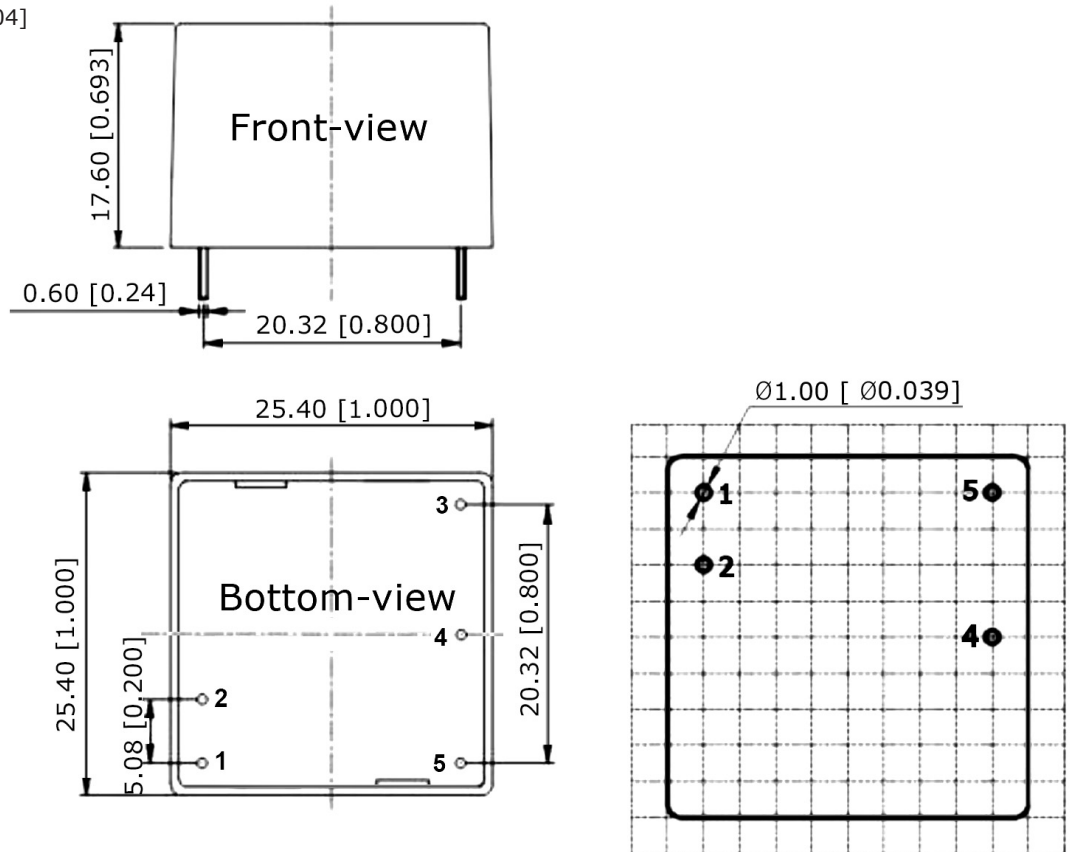
Board mount

units: mm [inch]

pin diameter tolerance: ± 0.10 [± 0.004]

tolerance: ± 0.50 [± 0.020]

PIN CONNECTIONS	
PIN	Function
1	AC(N)
2	AC(L)
3	no pin
4	-Vo
5	+Vo



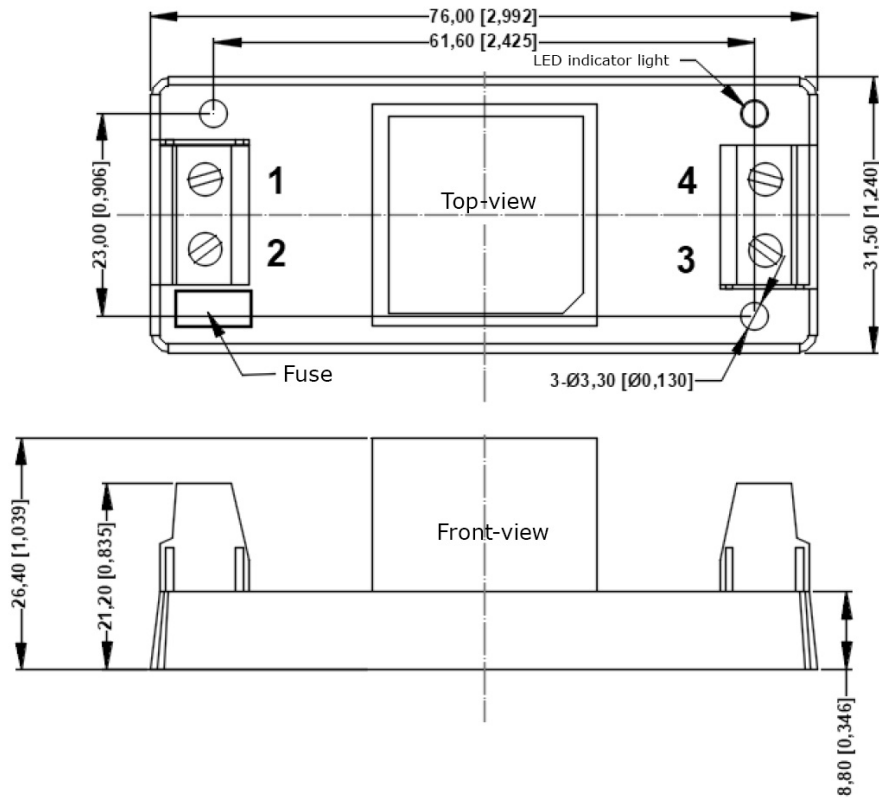
Grid size: 2.54*2.54mm

MECHANICAL DRAWING (CONTINUED)

Chassis mount

units: mm [inch]
 wire diameter: 24 ~ 12 AWG
 tightening torque: Max 0.4 N·m
 tolerance: ±1.00 [±0.039]

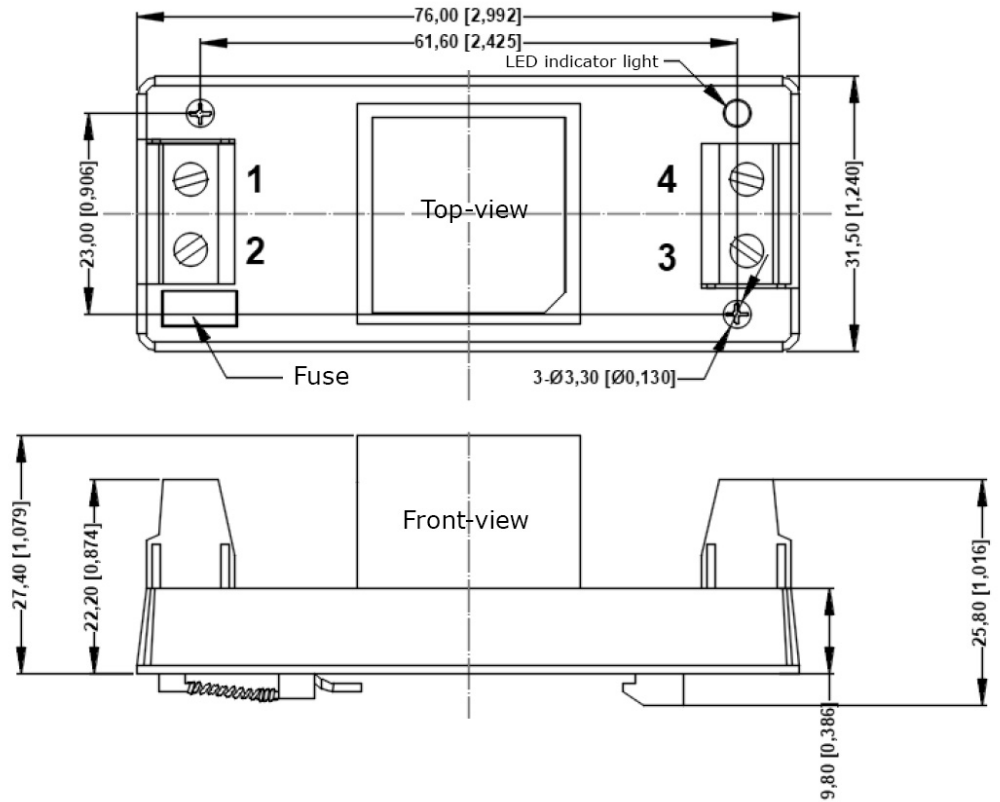
PIN CONNECTIONS	
PIN	Function
1	AC(N)
2	AC(L)
3	-Vo
4	+Vo



DIN-rail mount

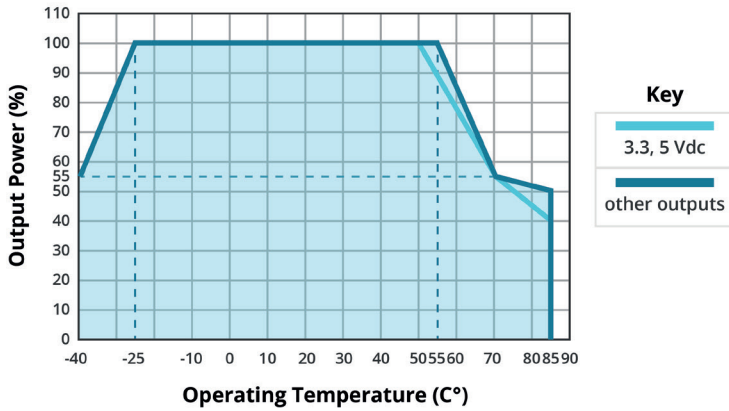
units: mm [inch]
 wire diameter: 24 ~ 12 AWG
 tightening torque: Max 0.4 N·m
 mounting rail: TS35,
 rail needs to connect to safety ground
 tolerance: ±1.00 [±0.039]

PIN CONNECTIONS	
PIN	Function
1	AC(N)
2	AC(L)
3	-Vo
4	+Vo

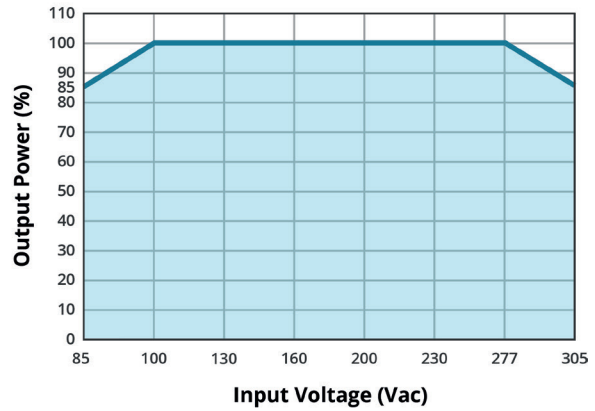


DERATING CURVE

TEMPERATURE DERATING CURVE
(Input voltage = 85 ~305 Vac)

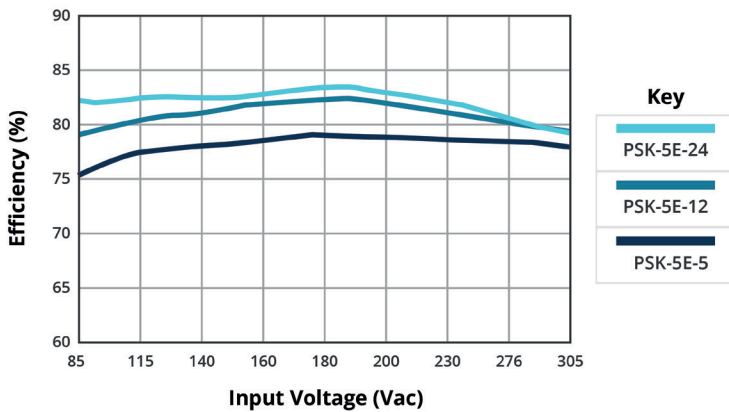


INPUT VOLTAGE DERATING CURVE
(at 25°C)

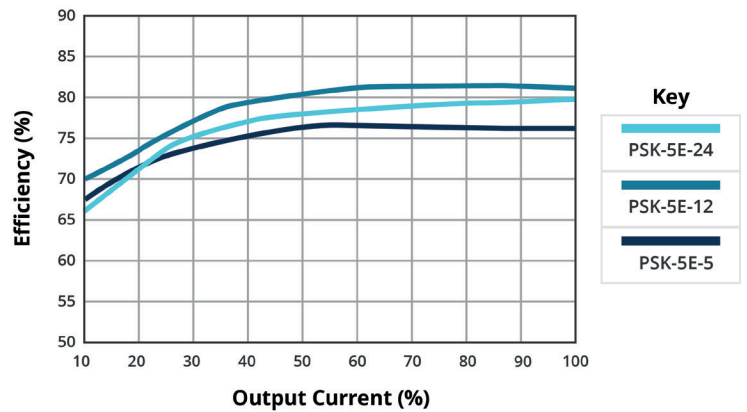


EFFICIENCY CURVES

EFFICIENCY VS INPUT VOLTAGE
(Full load)



EFFICIENCY VS OUTPUT LOAD
(Vin = 230 Vac)



APPLICATION DESIGN REFERENCE

Figure 1

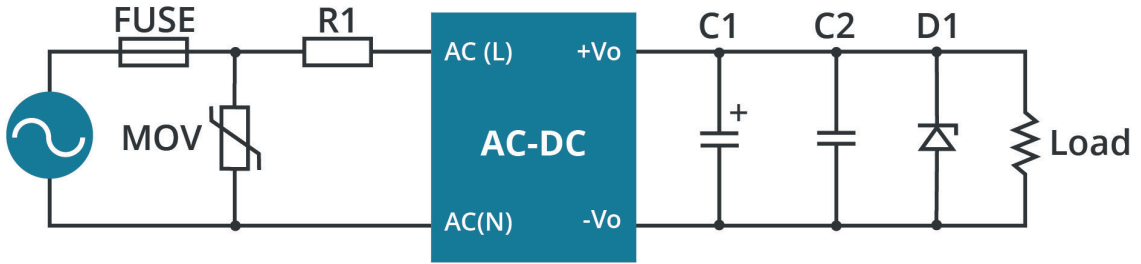


Table 1

Vout (Vdc)	FUSE	MOV	R1	C1 (μF/V)	C2(μF/V)	D1
3.3, 5	1A/300V, slow-blow, required	10D561K	12Ω/3W (wire-wound resistor, required)	1 μF/16 V	150 μF/16 V	see note 2
9, 12				1 μF/25 V	150 μF/25 V	
15, 24				1 μF/50 V	100 μF/35 V	

Notes: 1. Fuse and MOV should be selected based on application requirements and performance criteria.
 2. D1 is a TVS transistor that can protect the downstream circuit in case of module abnormalities. It is recommended to choose a model that is 1.2 times the output voltage.

RECOMMENDED CIRCUIT FOR HIGHER EMI REQUIREMENTS

Figure 2

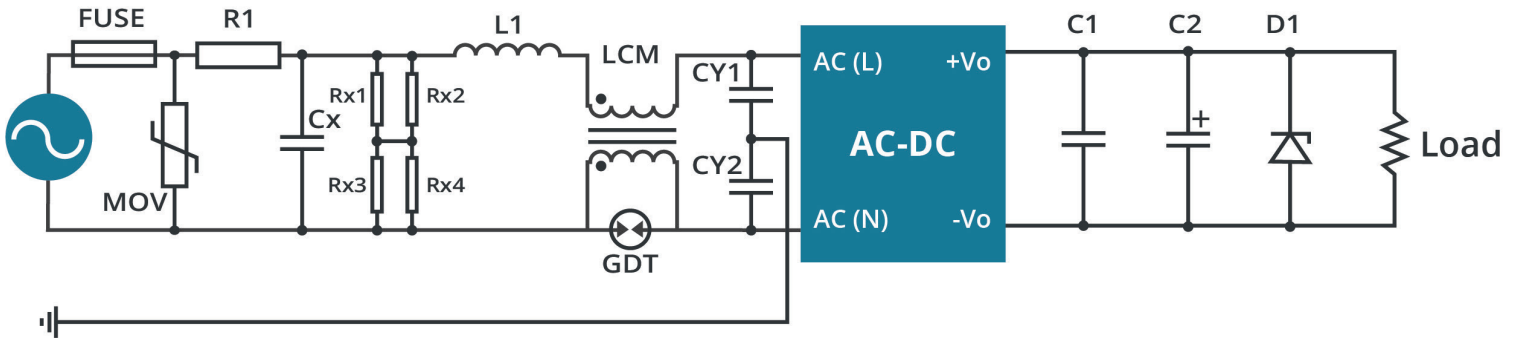


Table 2

Components	Recommended Value
FUSE	2A/300V, slow-blow, required
MOV	14D561K
Cx	0.33 μF/305 Vac
R1	12Ω/3W (wire wound resistor, required)
L1	1.2 mH/0.3 A
CY1, CY2	1nF/400 Vac
GDT	300 V/1 kA
LCM	20 mH Common mode Choke
Rx1, Rx2, Rx3, Rx4	2 MΩ/1206

REVISION HISTORY

rev.	description	date
1.0	initial release	04/07/2025
1.01	chassis and DIN-rail mount added	01/19/2026

The revision history provided is for informational purposes only and is believed to be accurate.



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